Notice: This is not a final specification Some parametric are subject to change.

High Speed Switching Silicon N-channel MOSFET

## **DESCRIPTION**

INK0602BC1 is a Silicon N-channel MOSFET.

This product is most suitable for use such as portable machinery, because of low voltage drive and low on resistance.

## **FEATURE**

- •Input impedance is high, and not necessary to consider a drive electric current.
- •High drain current ID=6.2A
- •Drive voltage 1.8V
- •Low on Resistance. RDS(ON)=18m  $\Omega$  typ(@VGS=4.5V)

RDS(ON)= $21 \text{m} \Omega \text{typ}(@VGS=2.5V.$ 

RDS(ON)= $25m\Omega typ(@VGS=1.8V)$ 

· High speed switching.

# **APPLICATION**

High speed switching, Analog switching

# MAXIMUM RATINGS (Ta=25°C)

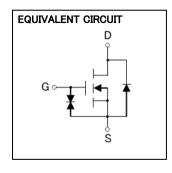
Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	VDSS	20	V	
Gate-Source Voltage	Vgss	±10	٧	
Drain Current(DC)(%1)	ĪD	6.2	Α	
Drain Current(Pulse) (%2)	<b>I</b> DP	12	Α	
Total Power Dissipation (※1)	PD	0.9	W	
Channel Temperature	Tch	+150	°C	
Storage Temperature	Tstg	-55 <b>∼</b> +150	°C	

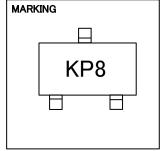
X1 package mounted on glass-epoxy substrate.

(39mm × 39mm × 1.6mm,Cu pad 1500mm<sup>2</sup>)

**※2** Pw≦10ms , Duty cycle≦1%

# OUTLINE DRAWING 2.8 0.65 1.5 0.65 1.5 0.65 TERMINAL CONNECTOR ①: GATE ②: SOURCE ③: DRAIN Unit:mm 2.8 El'0 FOOT POOT SOURCE JEITA: SC-59 JEDEC: Similar to TO-236 3: DRAIN





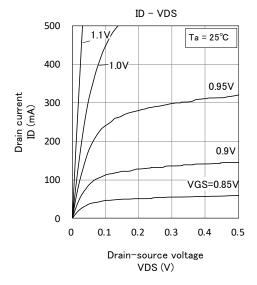
# ELECTRICAL CHARACTERISTICS (Ta=25°C)

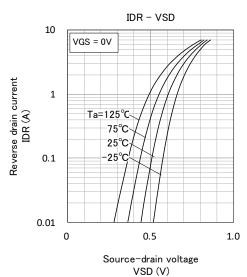
Parameter Sy		Test Condition		Limit		
	Symbol		MIN	TYP	MAX	Unit
Drain-Source Breakdown Voltage	V(BR)DSS	I <sub>D</sub> =250μA, V <sub>G</sub> s=0V	20	-	-	V
Gate-Source Leak Current	Igss	Vgs=±10V, Vps=0V	-	-	±10	μA
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V	-	-	1.0	μA
Gate Threshold Voltage	Vth	ID=250μA, VDS=VGS	0.3	-	1.0	V
Static Drain-Source On-State Resistance	Rds(on)	ID=6.2A, VGS=4.5V	-	18	23	mΩ
		ID=4.0A, VGS=2.5V	-	21	29	
		ID=3.0A, VGS=1.8V	-	25	31	
Input Capacitance	Ciss	VDS=10V, VGS=0V, f=1MHz	-	1050	-	pF
Output Capacitance	Coss			145	-	
Feedback Capacitance	Crss		_	10	-	
Switching Time	ton	V <sub>DD</sub> =20V, I <sub>D</sub> =200mA, V <sub>GS</sub> =5V	_	30	-	ns
	toff		_	290	_	

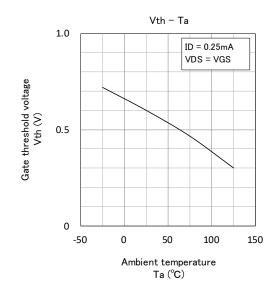
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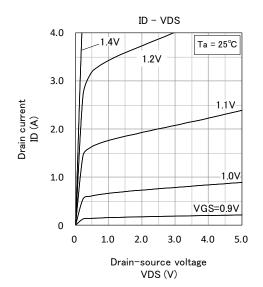
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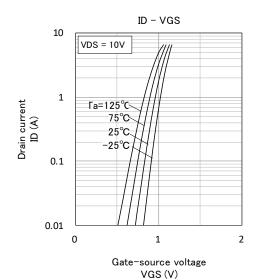
# TYPICAL CHARACTERISTICS

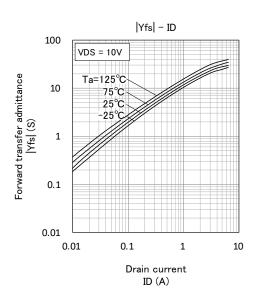








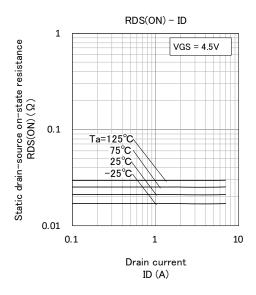


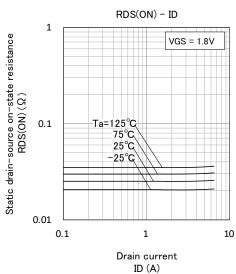


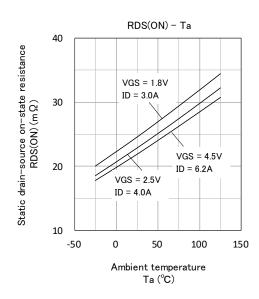
# INK0602BC1

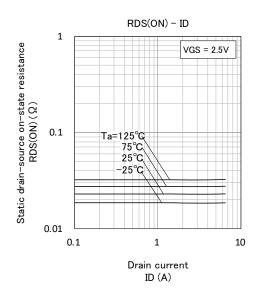
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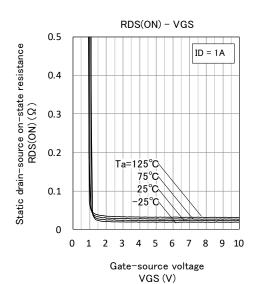
High Speed Switching Silicon N-channel MOSFET

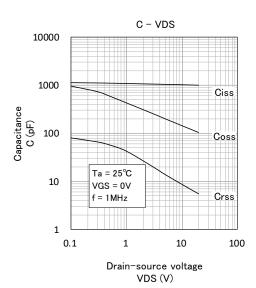








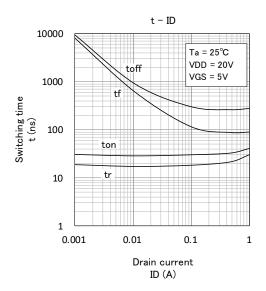


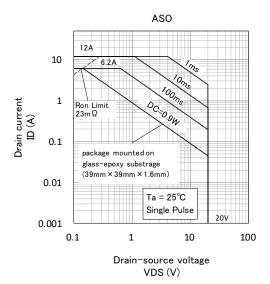


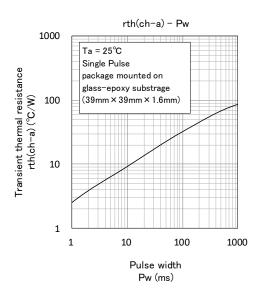
# INK0602BC1

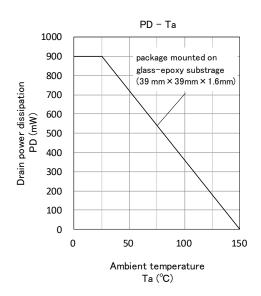
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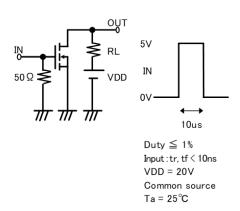


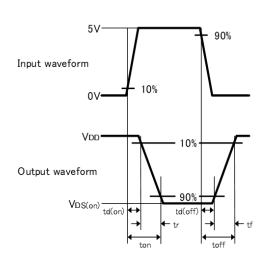






## Switching time test condition





### Keep safety first in your circuit designs!

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